



**EXPEDITED PROCEDURE – EXAMINING GROUP 2814**

**S/N 09/854539**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Intel Corporation	Examiner:	Ginette Peralta
Serial No.:	09/854539	Group Art Unit:	2814
Filed:	May 14, 2001	Docket No.:	884.415US1
Title:	POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR USE IN MICROELECTRONIC CIRCUIT PACKAGING		
Assignee:	Intel Corporation	Customer No.:	21186

---

**AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Final Office Action mailed December 17, 2003, please amend the application as follows: